

MOSFET - Power, Single N-Channel 60 V, 9 mΩ, 48 A NVLJWS011N06CL

Features

- Small Footprint for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	60	V
Gate-to-Source Voltage	Э		V _{GS}	±20	V
Continuous Drain	Steady	T _C = 25°C	I _D	48	Α
Current R _{θJC} (Notes 1, 3)		T _C = 100°C		34	
Power Dissipation	State	T _C = 25°C	P_{D}	46	W
R _{θJC} (Note 1)		T _C = 100°C		23	
Continuous Drain	Steady State	T _A = 25°C	I _D	12	Α
Current R _{0JA} (Notes 1, 2, 3)		T _A = 100°C		8.5	
Power Dissipation		T _A = 25°C	P_{D}	2.9	W
R _{θJA} (Notes 1, 2)		T _A = 100°C		1.4	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \mu s$		I _{DM}	233	Α
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +175	°C
Source Current (Body Diode)			I _S	38	Α
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 2.3 A)			E _{AS}	103	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		T _L	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

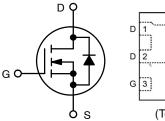
THERMAL RESISTANCE

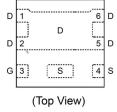
Parameter	Symbol	Value	Unit
Junction-to-Case	$R_{\theta JC}$	3.3	°C/W
Junction-to-Ambient	$R_{\theta JA}$	52	

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
- Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	9 mΩ @ 10 V	48 A
00 V	13 mΩ @ 4.5 V	70 A

ELECTRICAL CONNECTION





N-CHANNEL MOSFET



WDFNW6 (2.05x2.05) CASE 515AD

MARKING DIAGRAM



XXXX = Specific Device Code

A = Assembly Location

L = Wafer Lot Y = Year

W = Work Week

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Test Conditions		Min	Тур	Max	Unit
OFF CHARACTERISTICS					•	•	•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /				27.5		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$,	T _J = 25°C			10	μΑ
		V _{DS} = 60 V	T _J = 125°C			100	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS}	; = 20 V			100	nA
ON CHARACTERISTICS (Note 4)						•	
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D = 10 A			7.7	9	mΩ
		V _{GS} = 4.5 V, I _E	₎ = 10 A		10.7	13	
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 34 μΑ	1.2		2.0	٧
Gate Threshold Voltage Temperature Coefficient	V _{GS(TH)} /T _J				-5.6		mV/°C
Forward Transconductance	9FS	V _{DS} =6 V, I _D	= 10 A		39		S
CHARGES AND CAPACITANCES	•				•	•	•
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			912		pF
Output Capacitance	C _{OSS}				460		1
Reverse Transfer Capacitance	C _{RSS}				8		
Total Gate Charge	Q _{G(TOT)}	V _{DS} = 48 V; I _D = 10 A, V _{GS} = 4.5 V			6.3		nC
Total Gate Charge	Q _{G(TOT)}				13.6		nC
Threshold Gate Charge	Q _{G(TH)}	$V_{DS} = 48 \text{ V}; I_D = 10 \text{ A},$ $V_{GS} = 10 \text{ V}$			1.4		
Gate-to-Source Charge	Q _{GS}				2.5		
Gate-to-Drain Charge	Q _{GD}				1.4		
Plateau Voltage	V _{GP}				2.7		V
SWITCHING CHARACTERISTICS (Note 5)						•	
Turn-On Delay Time	t _{d(ON)}				8.1		ns
Turn-Off Delay Time	t _{d(OFF)}	VGs = 10 V. Vns	a = 48 V.		23.3		
Rise Time	t _r	V_{GS} = 10 V, V_{DS} = 48 V, I_D = 10 A, R_G = 6 Ω			3.0		
Fall Time	t _f				3.6		
SOURCE-TO-DRAIN DIODE CHARACTER	RISTICS					•	
Forward Diode Voltage	V _{SD}	VGS - U V,	T _J = 25°C		0.82	1.2	V
			T _J = 125°C		0.69		1
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dl/dt = 100 A/μs, I _{SD} = 10 A, V _{DS} = 48 V			32		ns
Charge Time	ta				15.8		1
Discharge Time	t _b				16		1
Reverse Recovery Charge	Q _{RR}				20		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.

5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS

R_{DS(on)}, DRAIN-TO-SOURCE RESISTANCE (mΩ)

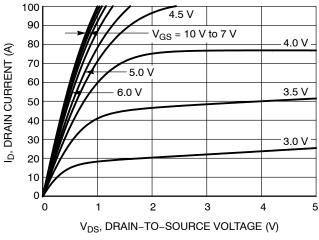


Figure 1. On-Region Characteristics

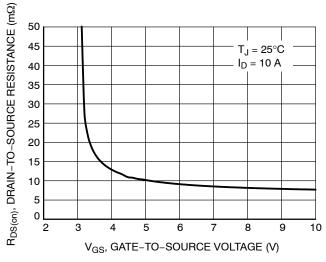


Figure 3. On-Resistance vs. Gate-to-Source Voltage

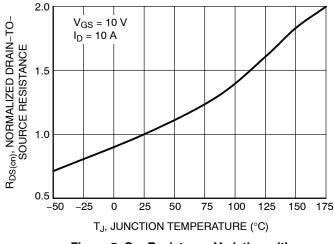
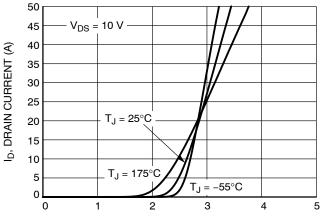


Figure 5. On–Resistance Variation with Temperature



V_{GS}, GATE-TO-SOURCE VOLTAGE (V)



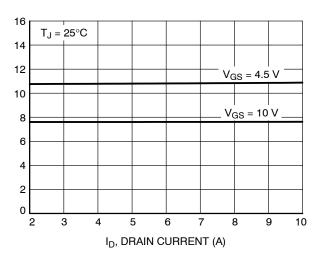


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

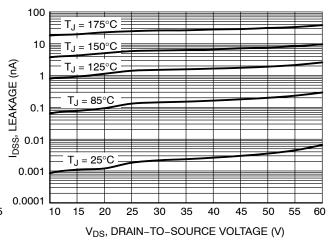


Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL CHARACTERISTICS

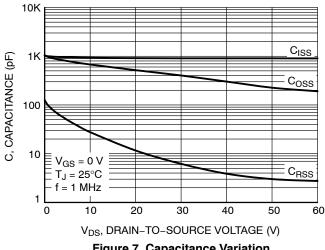


Figure 7. Capacitance Variation

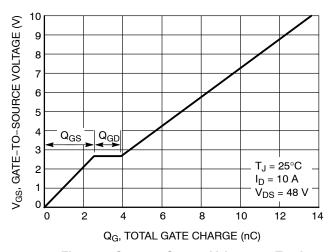


Figure 8. Gate-to-Source Voltage vs. Total Charge

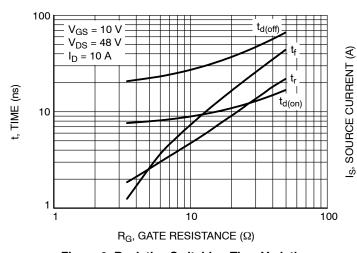


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

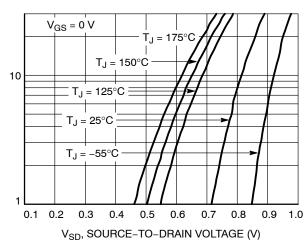


Figure 10. Diode Forward Voltage vs. Current

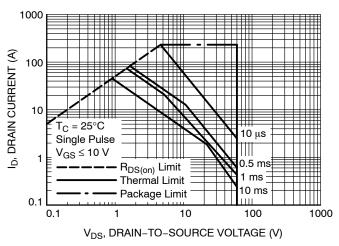


Figure 11. Maximum Rated Forward Biased Safe Operating Area

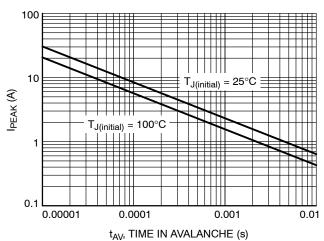


Figure 12. Maximum Drain Current vs. Time in **Avalanche**

TYPICAL CHARACTERISTICS

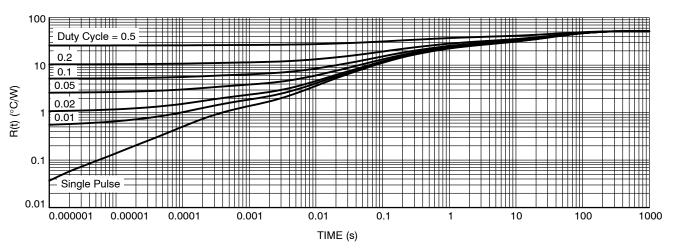


Figure 13. Transient Thermal Impedance

DEVICE ORDERING INFORMATION

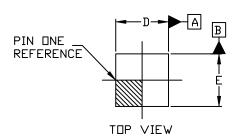
Device	Marking	Package	Shipping [†]
NVLJWS011N06CLTAG	011N	WDFNW6 (Pb-Free, Wettable Flanks)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

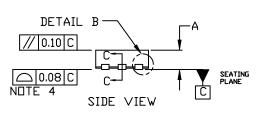
WDFNW6 2.05x2.05, 0.65P

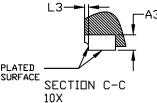
CASE 515AD **ISSUE O**

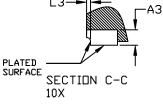


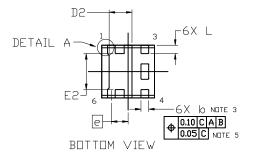
NOTES:

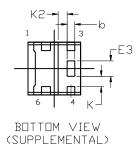
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M,
- 2009.
 CONTROLLING DIMENSION: MILLIMETERS
 DIMENSION & APPLIES TO PLATED TERMINALS AND IS
 MEASURED BETWEEN 0.15 AND 0.30MM FROM THE
- TERMINAL TIP.
 COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL
 AS THE TERMINALS.
 POSITIONAL TOLERANCE APPLIES TO THE EXPOSED PAD
 AS WELL AS THE TERMINALS.



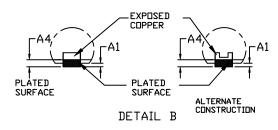


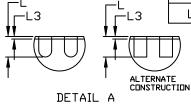


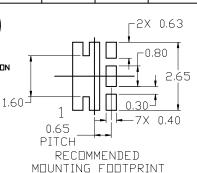




	MILLIMETERS			
DIM	MIN.	N□M.	MAX.	
Α	0.70	0.75	0.80	
A1	0.00		0.05	
A3	ľ	0.20 REF	-	
Α4	0.10		-	
b	0.25	0.30	0.35	
D	1.95	2.05	2.15	
D2	0.84	0.89	0.94	
E	1.95	2.05	2.15	
E2	1.35	1.40	1,45	
E3	0.55	0.60	0.65	
е	0.65 BSC			
K	0.40 REF			
K2	0.35 REF			
L	0.275	0.325	0.375	
L3			0.09	







For additional information on our Pb-Free strategy and soldering details, please download the IIN Seniconductor Soldering and Mounting Techniques Reference Manual, SILLERRHYD.

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